

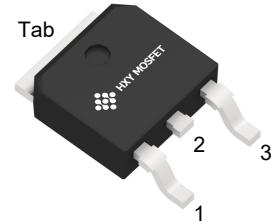


Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Avalanche Ruggedness

Applications

- Solar Inverters
- Switch Mode Power Supplies
- UPS
- Battery Chargers

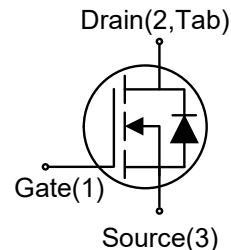


TO-252-2L



Package Marking and Ordering Information

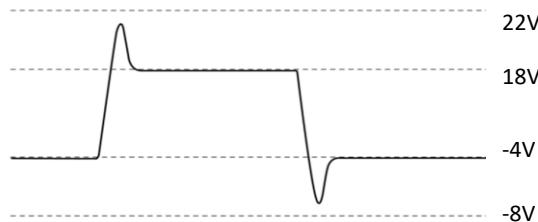
Ordering Part Number	Package	Brand
TK9P65W,RQ	TO-252-2L	HXY MOSFET



Absolute Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions
V_{DSmax}	Drain - Source Voltage	650	V	
V_{GSmax}	Gate - Source Voltage (Absolute maximum values)	-8/+22	V	
V_{GS}	Gate - Source Voltage	-4/+18	V	
I_D	Continuous Drain Current	6.8	A	$T_C = 25^\circ C$
		4.8		$T_C = 100^\circ C$
$I_{D(pulse)}$	Pulsed Drain Current	29	A	Pulse width t_p limited by T_{jmax}
P_{TOT}	Power Dissipation	41	W	$T_C = 25^\circ C$
T_J, T_{stg}	Operating Junction and Storage Temperature	-55 to +175	°C	

• Example of acceptable V_{GS} waveform





Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value			Unit	Test Condition
		min.	typ.	max.		
Static Characteristics						
V_{DSS}	Drain-source breakdown voltage	750	-	-	V	$V_{GS}=0\text{V}, I_D=100\mu\text{A}$
$V_{GS(\text{th})}$	Gate threshold voltage	2	2.8	4	V	$V_{DS}=V_{GS}, I_D=0.43\text{mA}$
I_{DSS}	Zero gate voltage drain current	-	1	10	μA	$V_{DS}=650\text{V}, V_{GS}=0\text{V}$ $T_c=25^\circ\text{C}$ $T_c=175^\circ\text{C}$
I_{GSS}	Gate-source leakage current	-		100	nA	$V_{GS}=18\text{V}, V_{DS}=0\text{V}$
$R_{DS(\text{on})}$	Drain-source on-state resistance	-	460 540	610	$\text{m}\Omega$	$V_{GS}=18\text{V}, I_D=2\text{A},$ $T_J=25^\circ\text{C}$ $T_J=175^\circ\text{C}$
$R_{DS(\text{on})}$	Drain-source on-state resistance	-	580	-	$\text{m}\Omega$	$V_{GS}=15\text{V}, I_D=2\text{A}, T_J=25^\circ\text{C}$
g_{fs}	Transconductance	-	1.3	-	S	$V_{DS}=20\text{V}, I_D=2\text{A}$
Dynamic Characteristics						
C_{iss}	Input Capacitance	-	176	-	pF	$V_{DS} = 400\text{V}$ $V_{GS} = 0\text{V}$ $T_J = 25^\circ\text{C}$ $V_{AC} = 25\text{mV}$ $f = 1\text{MHz}$
C_{oss}	Output Capacitance	-	17	-		
C_{rss}	Reverse Transfer Capacitance	-	2	-		
Q_G	Gate Total Charge	-	8.5	-	nC	$V_{DS} = 400\text{V}$ $V_{GS} = -4/18\text{V}$ $I_D = 1.6\text{A}$
Q_{gs}	Gate-Source charge	-	2.6	-		
Q_{gd}	Gate-Drain charge	-	2.6	-		
E_{ON}	Turn-On Switching Energy	-	32.5	-	μJ	$V_{DD} = 400\text{V}$ $V_{GS} = -4/18\text{V}$ $I_D = 1.6\text{A}$ $R_G = 5\Omega$
E_{OFF}	Turn-Off Switching Energy	-	0.53	-		
$t_{d(on)}$	Turn-on delay time	-	40	-		
t_r	Rise time	-	33.5	-	ns	
$t_{d(off)}$	Turn-off delay time	-	49	-		
t_f	Fall time	-	54	-		
R_G	Gate resistance	-	3.7	-	Ω	$V_{AC} = 25\text{mV}, f=1\text{MHz}$
Body Diode Characteristics						
V_{SD}	Body Diode Forward Voltage		3		V	$V_{GS}=0\text{V}, I_{SD}=1\text{A},$ $T_J=25^\circ\text{C}$
			2.7			$V_{GS}=0\text{V}, I_{SD}=1\text{A},$ $T_J=175^\circ\text{C}$
t_{rr}	Body Diode Reverse Recovery Time	-	52	-	ns	$V_R = 400\text{V}, V_{GS} = 0\text{V}$ $I_D = 1.6\text{A}$ $di/dt = 800\text{A}/\mu\text{s}$ $T_J = 175^\circ\text{C}$
Q_{rr}	Body Diode Reverse Recovery Charge	-	21.8	-	nC	



Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Test Conditions
R_{thJC}	Thermal Resistance from Junction to Case	3.7	°C/W	
R_{thJA}	Thermal Resistance From Junction to Ambient	40		

Typical Performance

Fig 1. Output Characteristics ($T_J = -55^\circ\text{C}$)

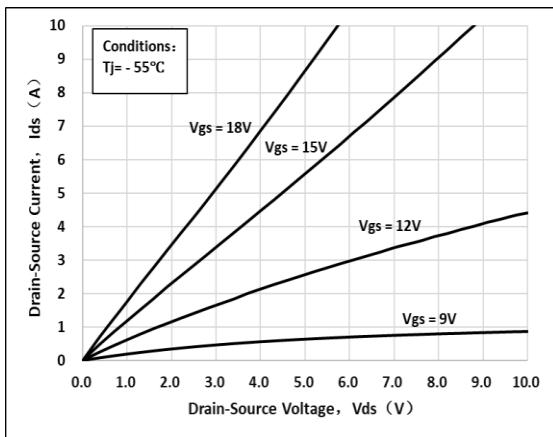


Fig 2. Output Characteristics ($T_J = 25^\circ\text{C}$)

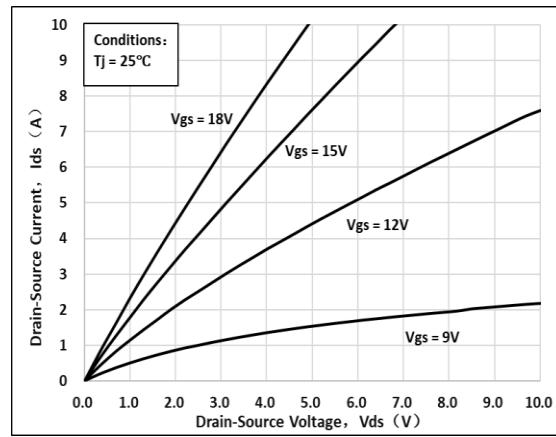


Fig 3. Output Characteristics ($T_J = 175^\circ\text{C}$)

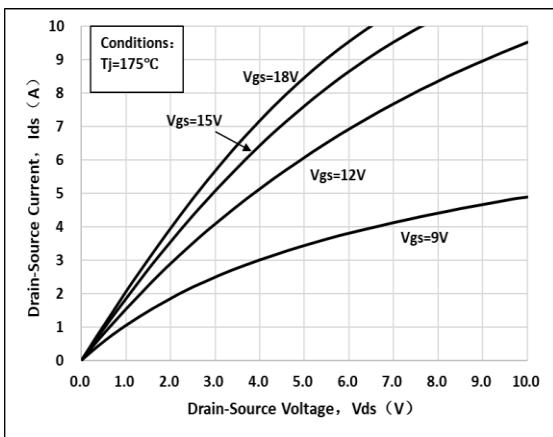


Fig 4: $R_{ds(on)}$ Vs Id_s Characteristics

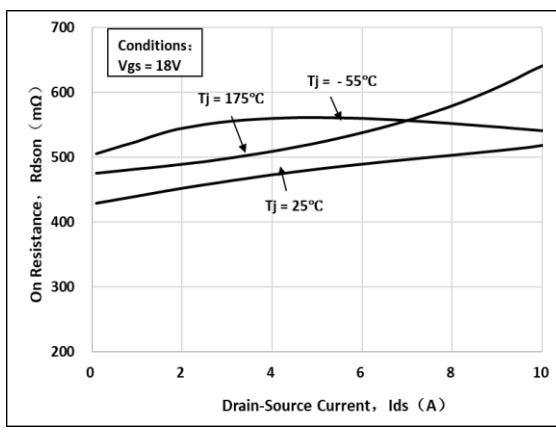




Fig 5: $R_{ds(on)}$ vs. Temperature

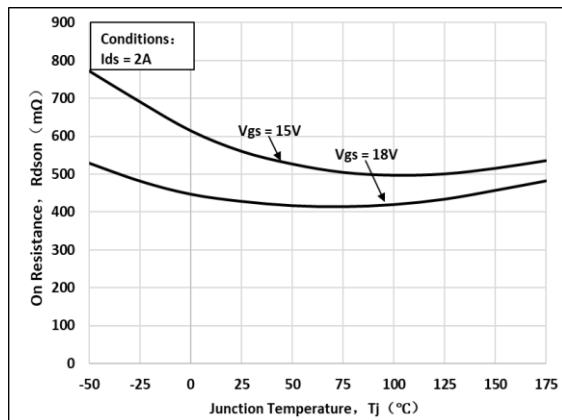


Fig 5: Transfer Characteristics

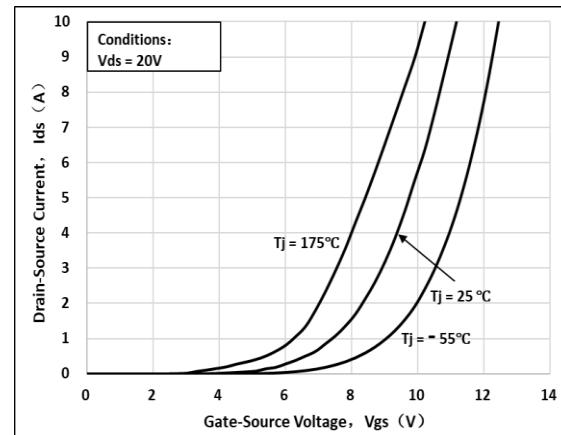


Fig 7: Body-diode Characteristics ($T_j = -55^\circ\text{C}$)

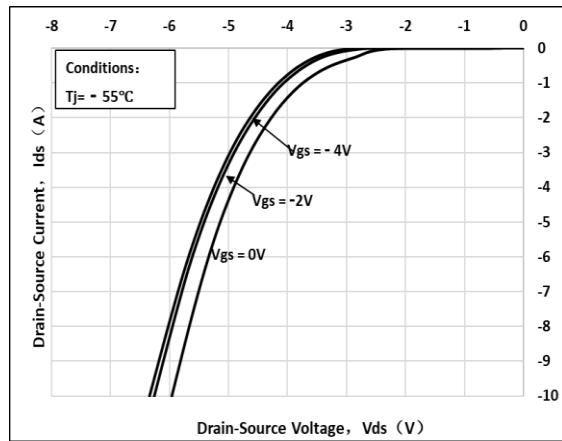


Fig 8: Body-diode Characteristics ($T_j = 25^\circ\text{C}$)

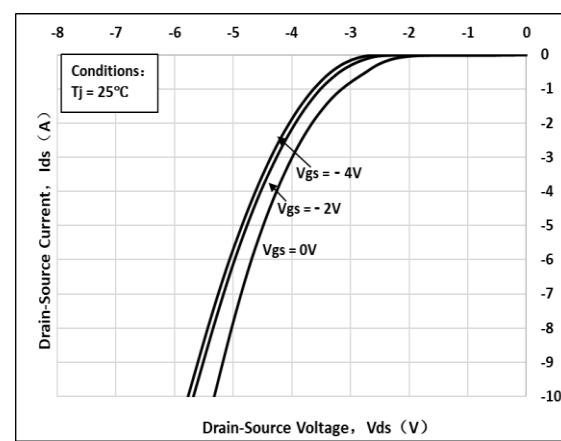


Fig 9: Body-diode Characteristics ($T_j = 175^\circ\text{C}$)

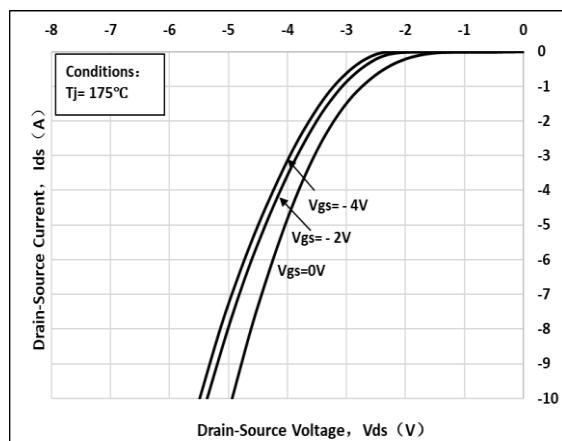


Fig 10: V_{th} Vs T_j Temperature Characteristics

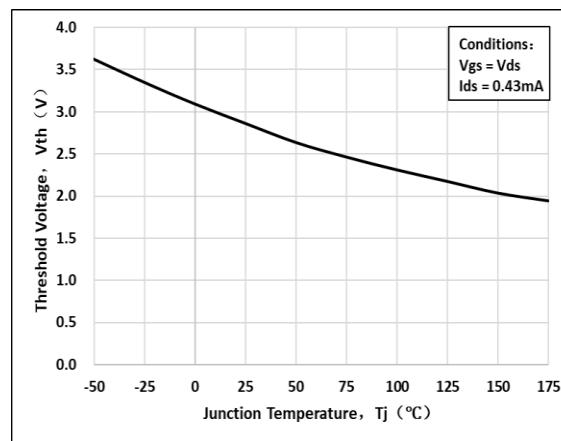




Fig 11: 3rd Quadrant Characteristics($T_j = -55^\circ\text{C}$)

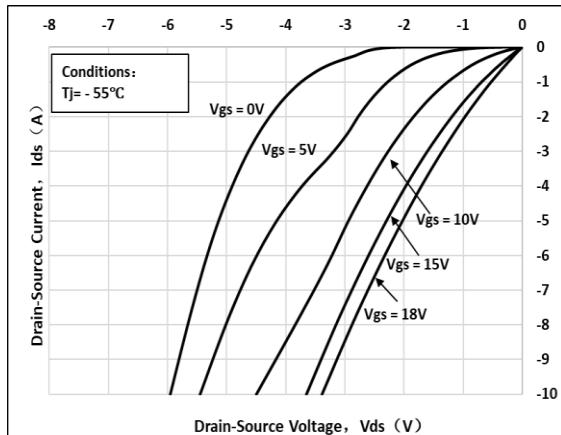


Fig 12: 3rd Quadrant Characteristics($T_j = 25^\circ\text{C}$)

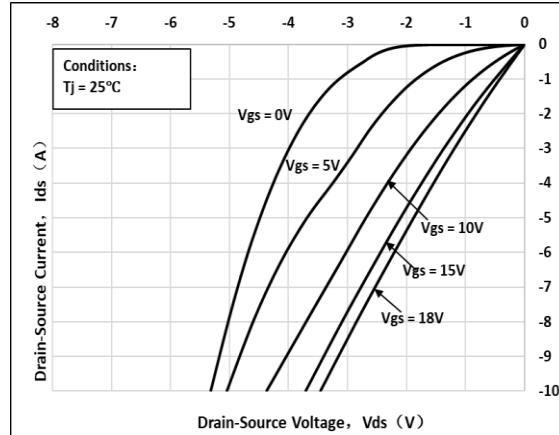


Fig 13: 3rd Quadrant Characteristics($T_j = 175^\circ\text{C}$)

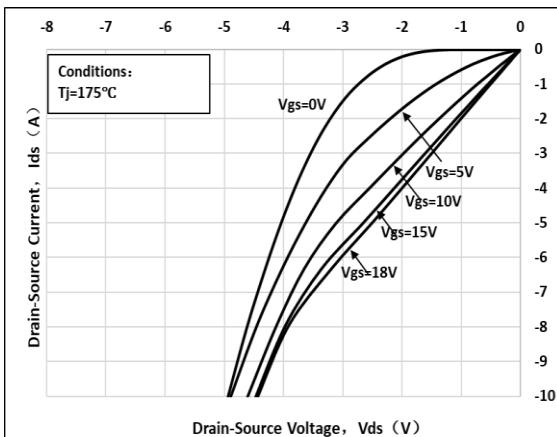


Fig 14: Gate Charge Characteristics

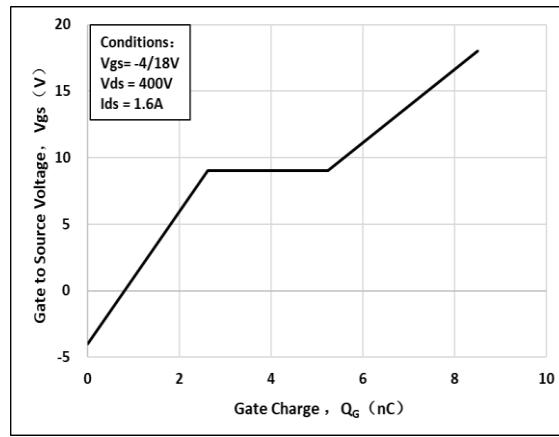


Fig 15: Continuous Drain Current vs. Case Temperature

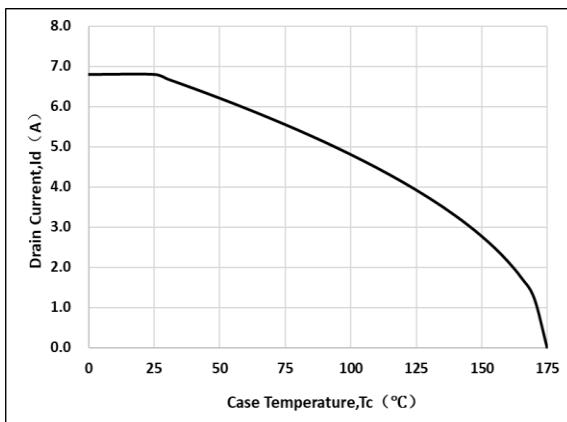


Fig 16: Safe Operating Area

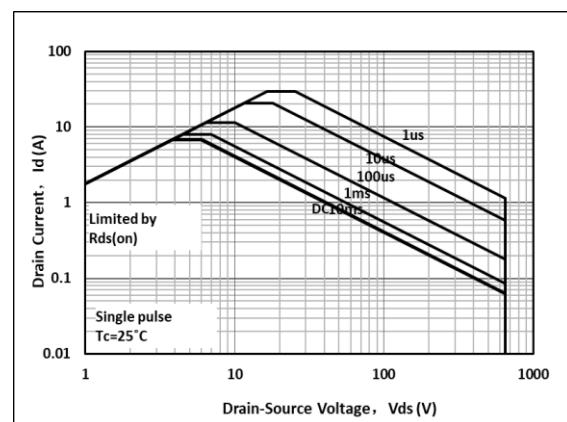




Fig 17: Capacitance Characteristics

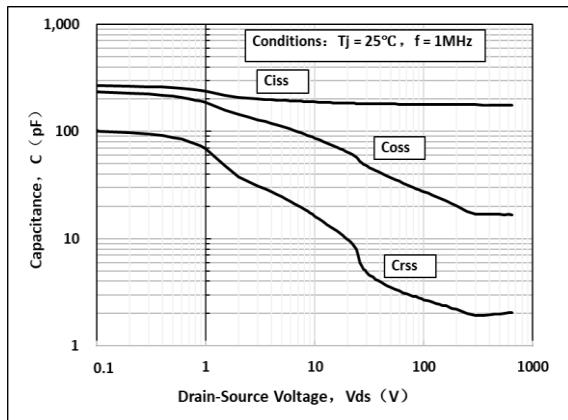
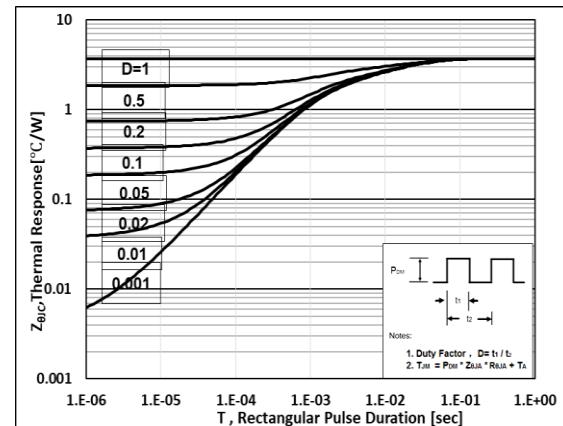


Fig 18: Transient Thermal Impedance



Test Circuit & Waveform

Figure A. Definition of switching times

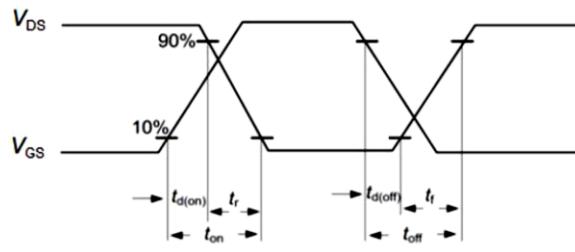


Figure B. Dynamic test circuit

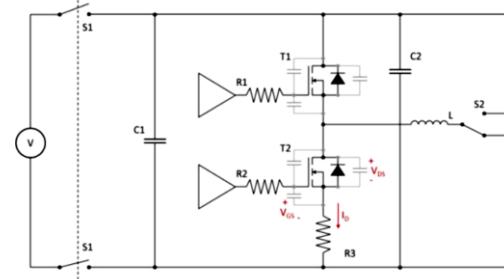


Figure C. Definition of body diodeswitching characteristics

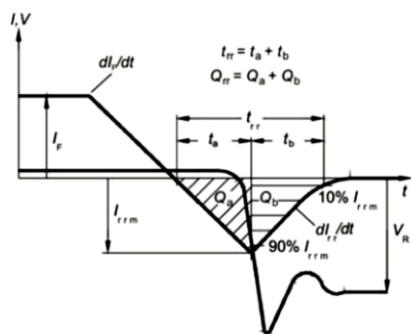
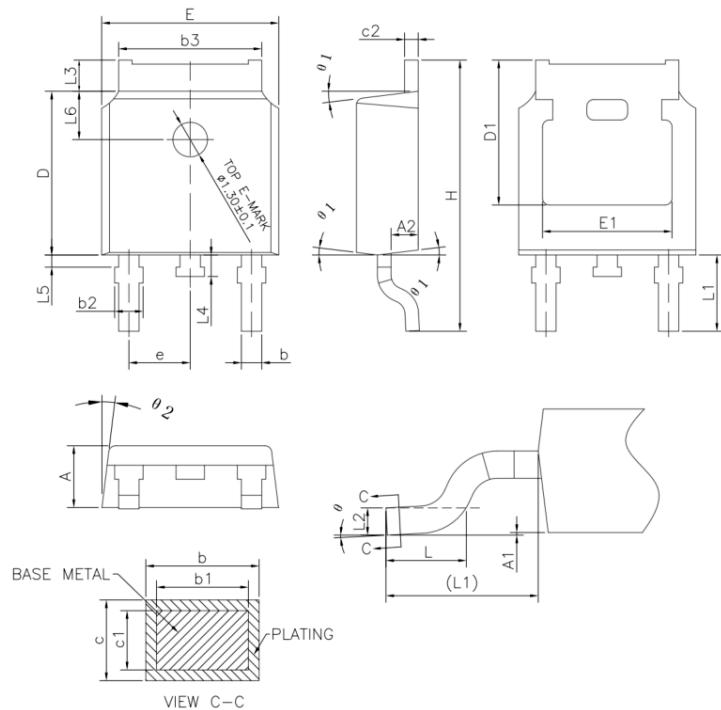


Figure C. Definition of diode switching characteristics

Package Dimensions

Package TO-252-2L



SYMBOL	Unit: mm		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0	-	0.10
A2	0.90	1.01	1.10
b	0.72	-	0.85
b1	0.71	0.76	0.81
b2	0.72	-	0.90
b3	5.13	5.33	5.46
c	0.47	-	0.60
c1	0.46	0.51	0.56
c2	0.47	-	0.60
D	6.00	6.10	6.20
D1	5.25	-	-
E	6.50	6.60	6.70
E1	4.70	-	-
e	2.186	2.286	2.386
H	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90 REF		
L2	0.508 BSC		
L3	0.90	-	1.25
L4	0.60	0.80	1.00
L5	0.15	-	0.75
L6	1.80 REF		
θ	0°	-	8°
θ1	5°	7°	9°
θ2	5°	7°	9°



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